



450V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

| V _{(BR)DSS} | R _{DS(ON)} MAX | I _D T _A = +25°C |
|----------------------|------------------------------|--|
| 450V | 4Ω @ V_{GS} = $10V$ | 0.85A |

Description

This new generation complementary MOSFET features low onresistance and fast switching, making it ideal for high efficiency power management applications.

Applications

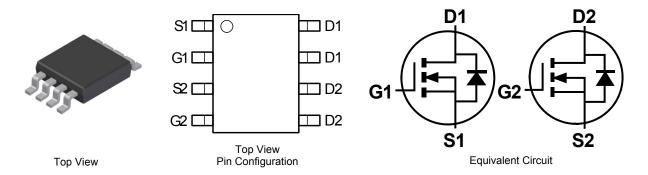
- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions

Features

- Low Input Capacitance
- High BVDss Rating for Power Application
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See diagram below
- Terminals: Finish Matte Tin annealed over Copper lead frame.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (approximate)



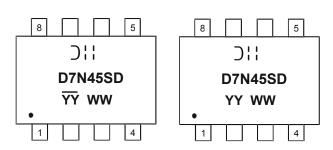
Ordering Information (Note 4)

| Ī | Part Number | Compliance | Case | Packaging |
|---|----------------|------------|------|-------------------|
| | DMGD7N45SSD-13 | Standard | SO-8 | 2,500/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Chengdu A/T Site Shanghai A/T Site

D7N45SD = Product Type Marking Code
YYWW = Date Code Marking
YY or YY = Year (ex: 14 = 2014)
WW = Week (01 - 53)

YY = Date Code Marking for SAT (Shanghai Assembly/ Test site)
YY = Date Code Marking for CAT (Chengdu Assembly/ Test site)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Units | |
|---|-------------------|-----------------|-------|------|
| Drain-Source Voltage | V_{DSS} | 450 | V | |
| Gate-Source Voltage | V _{GSS} | ±30 | V | |
| | Steady State | | 0.5 | А |
| Continuous Drain Current (Note 5) V _{GS} = 10V | t < 10s | I_{D} | 0.62 | |
| | t < 1s |] | 0.85 | Α |
| Pulsed Drain Current (10µs pulse, duty cycle = 1%) | I_{DM} | 2.2 | Α | |
| Maximum Body Diode Forward Current (Note 5) | Is | 1.7 | Α | |
| Avalanche Current (Note 6) | L = 60mH | I _{AS} | 1.4 | A |
| Availanche Current (Note 6) | L = 10mH (Note 8) | | 2.2 | |
| Avalanche Energy (Note 6) | L = 60mH | | 56 | - mJ |
| Avaianone Energy (Note o) | L = 10mH (Note 8) | E _{AS} | 25 | |

Thermal Characteristics

| Characteristic | Symbol | Value | Units | |
|--|------------------|-----------------|-------|------|
| Total Power Dissipation (Note 5) | | P _D | 1.64 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady state | Б | 78 | °C/W |
| Thermal Resistance, Junction to Ambient (Note 5) | t<10s | $R_{\Theta JA}$ | 20.2 | °C/W |
| Thermal Resistance, Junction to Case (Note 5) | R _{OJC} | 13.3 | °C/W | |
| Operating and Storage Temperature Range | $T_{J,}T_{STG}$ | -55 to +150 | °C | |

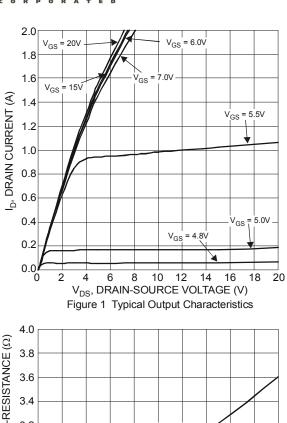
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

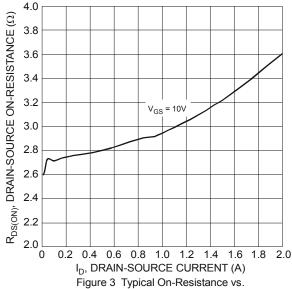
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|---|----------------------------------|------|------|------|---|---|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 450 | _ | _ | V | V _{GS} = 0V, I _D = 10mA | |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | _ | 1 | μΑ | V _{DS} = 450V, V _{GS} = 0V | |
| Gate-Source Leakage | I _{GSS} | _ | _ | ±100 | nA | $V_{GS} = \pm 30V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | 3.5 | _ | 4.5 | V | $V_{DS} = 10V I_D = 1mA$ | |
| Static Drain-Source On-Resistance | R _{DS (ON)} | _ | 3 | 4 | Ω | V _{GS} = 10V, I _D = 0.4A | |
| Forward Transfer Admittance | Y _{fs} | 0.55 | 1.1 | _ | S | V _{DS} = 10V, I _D =0.4A | |
| Diode Forward Voltage | V _{SD} | _ | 0.7 | 1.2 | V | V _{GS} = 0V, I _S = 0.7A | |
| DYNAMIC CHARACTERISTICS (Note 8) | DYNAMIC CHARACTERISTICS (Note 8) | | | | | | |
| Input Capacitance | C _{iss} | _ | 256 | _ | | V _{DS} = 25V, V _{GS} = 0V f = 1MHz | |
| Output Capacitance | Coss | _ | 22.5 | _ | pF | | |
| Reverse Transfer Capacitance | C _{rss} | _ | 0.83 | _ | | 1 - 1101112 | |
| Gate Resistance | R_{G} | _ | 2.3 | _ | Ω V _{DS} = 0V, V _{GS} = 0V, f = 1MHz | | |
| Total Gate Charge (V _{GS} = 10V) | Q_g | _ | 6.9 | _ | | V _{DS} = 360V,I _D = 0.7A, V _{GS} = 10V | |
| Gate-Source Charge | Q_{gs} | _ | 1.4 | _ | nC | | |
| Gate-Drain Charge | Q_{gd} | _ | 3.4 | _ | | | |
| Turn-On Delay Time | t _{D(on)} | _ | 7 | _ | | | |
| Turn-On Rise Time | t _r | _ | 6.4 | _ | nS | $V_{GS} = 10V, R_L = 562\Omega, R_G = 10\Omega,$ | |
| Turn-Off Delay Time | t _{D(off)} | _ | 18.9 | _ | 115 | I _D = 0.4A | |
| Turn-Off Fall Time | t _f | _ | 56.6 | _ | | | |
| Body Diode Reverse Recovery Time | t _{rr} | _ | 103 | _ | nS | L = 40 dl/dt = 4000/ | |
| Body Diode Reverse Recovery Charge | Q _{rr} | _ | 314 | _ | nC | I _F = 1A, dI/dt = 100A/μs | |

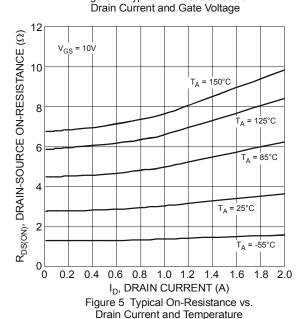
Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

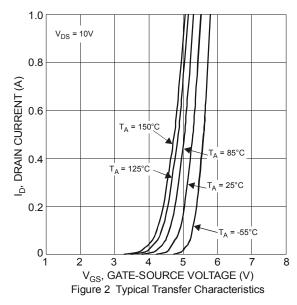
 ^{5.} La_R and E_{AR} rating are based on low frequency and duty cycles to keep T_J = +25°C.
 7. Short duration pulse test used to minimize self-heating effect.
 8. Guaranteed by design. Not subject to product testing.

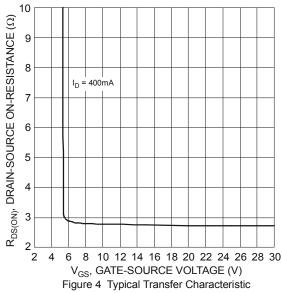


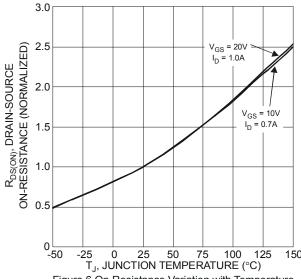




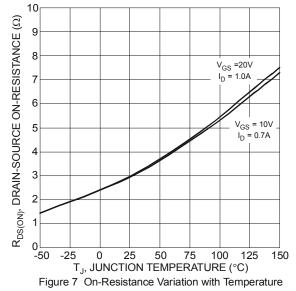


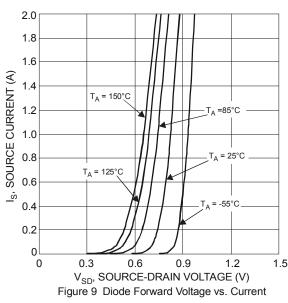


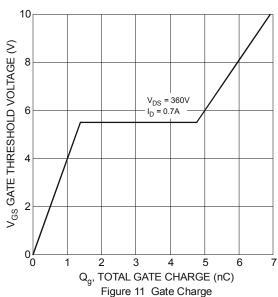












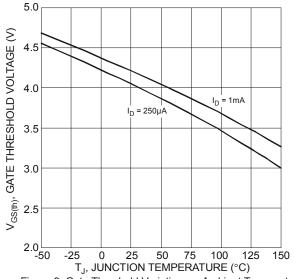
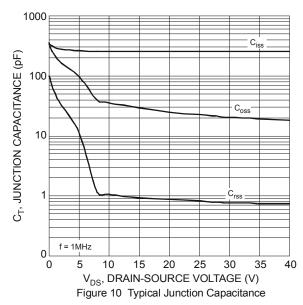


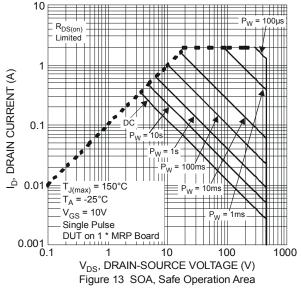
Figure 8 Gate Threshold Variation vs. Ambient Temperature

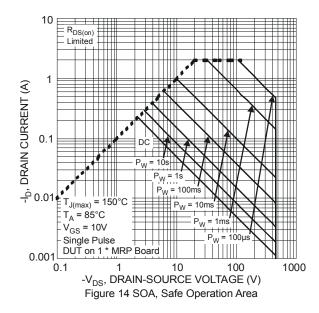


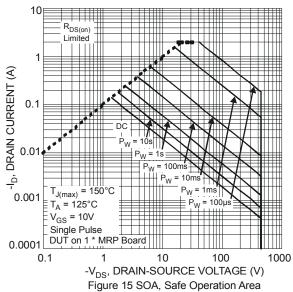
10
R_{DS(on)}
Limited

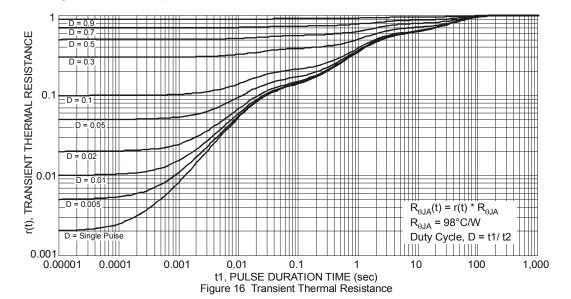
1
0.1
P_W = 100µs
P_W = 10µs
P_W = 10







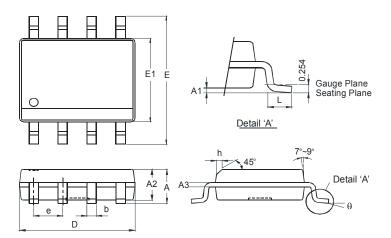






Package Outline Dimensions

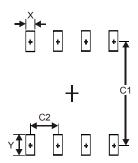
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



| SO-8 | | | | |
|----------------------|-----------|------|--|--|
| Dim | Min | Max | | |
| Α | _ | 1.75 | | |
| A 1 | 0.10 | 0.20 | | |
| A2 | 1.30 | 1.50 | | |
| A3 | 0.15 | 0.25 | | |
| b | 0.3 | 0.5 | | |
| D | 4.85 | 4.95 | | |
| Е | 5.90 | 6.10 | | |
| E1 | 3.85 3.95 | | | |
| е | 1.27 Typ | | | |
| h | _ | 0.35 | | |
| ٦ | 0.62 | 0.82 | | |
| θ | 0° 8° | | | |
| All Dimensions in mm | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Х | 0.60 |
| Y | 1.55 |
| C1 | 5.4 |
| C2 | 1.27 |



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